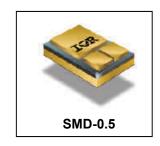


LOGIC LEVEL POWER MOSFET SURFACE MOUNT (SMD-0.5)

20V, P-CHANNEL

Product Summary

Part Number	BV _{DSS}	R _{DS(on)}	I _D	
IRL5NJ7404	-20V	0.04Ω	-11A	



Description

IRL5NJ7404 is part of the International Rectifier HiRel family of products. IR HiRel Fifth Generation Power MOSFETs utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon unit area. This benefit combined with the fast switching speed and ruggedized device design that Power MOSFETs are well known for, provide the designer with an extremely efficient device for use in a wide variety of applications. These devices are well-suitable for applications such as switching power supplies, motor established advantages of MOSFETs such as voltage controls, inverters, choppers, audio amplifiers and high-energy pulse circuits.

Features

- Logic Level Gate Drive
- Low RDS(on)
- Avalanche Energy Ratings
- Dynamic dv/dt Ratings
- Simple Drive Requirements
- Ease of Paralleling
- · Hermetically Sealed
- · Electrically Isolated
- Ceramic Package
- Light Weight
- Surface Mount

Absolute Maximum Ratings

	Parameter		Units
I _D @ V _{GS} = -10V, T _C = 25°C	Continuous Drain Current	-11	
I _D @ V _{GS} = -10V, T _C = 100°C	Continuous Drain Current	-7.0	Α
I _{DM}	Pulsed Drain Current ①	-44	
P _D @ T _C = 25°C	Maximum Power Dissipation	50	W
	Linear Derating Factor	0.4	W/°C
V_{GS}	Gate-to-Source Voltage	±12	V
E _{AS}	Single Pulse Avalanche Energy ②	157	mJ
I _{AR}	Avalanche Current ①	-11	Α
E _{AR}	Repetitive Avalanche Energy ①	5.0	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-0.7	V/ns
T _J	Operating Junction and	-55 to + 150	
T _{STG}	Storage Temperature Range		°C
	Lead Temperature	300 (for 5s)	
	Weight	1.0 (Typical)	g

For Footnotes, refer to the page 2.



Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	-20			V	$V_{GS} = 0V, I_{D} = -250\mu A$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		-0.14		V/°C	Reference to 25°C, I _D = -1.0mA
Б	Static Drain-to-Source On-Resistance			0.04	Ω	V _{GS} = -4.5V, I _D = -11A ④
R _{DS(on)}				0.07		V _{GS} = -2.7V, I _D = -7.0A ④
V _{GS(th)}	Gate Threshold Voltage	-0.7			V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Gfs	Forward Transconductance	9.0			S	V _{DS} = -15V, I _D = -3.2A ④
I _{DSS}	Zoro Coto Voltago Droin Current			-1.0		$V_{DS} = -16V, V_{GS} = 0V$
	Zero Gate Voltage Drain Current			-25	μΑ	$V_{DS} = -16V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I_{GSS}	Gate-to-Source Leakage Forward			-100	nA	$V_{GS} = -12V$
	Gate-to-Source Leakage Reverse			100	IIA	V _{GS} = 12V
Q_G	Total Gate Charge			50		I _D = -3.2A
Q_{GS}	Gate-to-Source Charge			5.5	nC	V _{DS} = -16V
Q_{GD}	Gate-to-Drain ('Miller') Charge			21		$V_{GS} = -4.5V$
t _{d(on)}	Turn-On Delay Time			35		V _{DD} = -10V
tr	Rise Time			150		$I_D = -3.2A$
t _{d(off)}	Turn-Off Delay Time			72	ns	$R_G = 6.0\Omega$
t _f	Fall Time			90		V _{GS} = -4.5V
Ls +L _D	Total Inductance		4.0		nΗ	Measured from center of Drain pad to center of Source pad
C _{iss}	Input Capacitance		1450			V _{GS} = 0V
Coss	Output Capacitance		830		pF	V _{DS} = -15V
C _{rss}	Reverse Transfer Capacitance		430			f = 1.0MHz

Source-Drain Diode Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)			-11	^	
I _{SM}	Pulsed Source Current (Body Diode) ①			-44	Α	
V_{SD}	Diode Forward Voltage			-1.0	V	T _J =25°C, I _S =-3.2A, V _{GS} =0V@
t _{rr}	Reverse Recovery Time			80	ns	$T_J=25^{\circ}C, I_F=-3.2A, V_{DD} \le -20V$
Q _{rr}	Reverse Recovery Charge			100	nC	di/dt = -100A/μs ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)				

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case			2.5	°C/W

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} = -15V, starting T_J = 25°C, L = 2.6mH, Peak I_L = -11A, V_{GS} = -10V
- $\label{eq:local_sd} \begin{tabular}{ll} \be$
- ⓐ Pulse width ≤ 300 μ s; Duty Cycle ≤ 2%

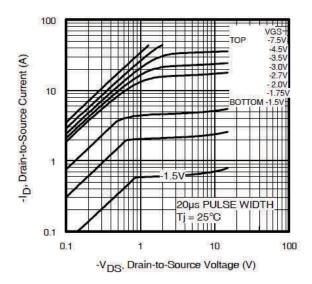


Fig 1. Typical Output Characteristics

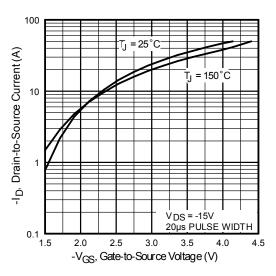


Fig 3. Typical Transfer Characteristics

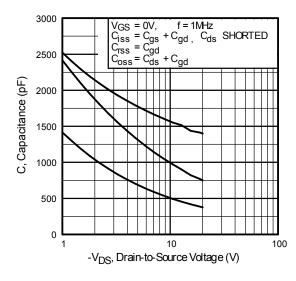


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

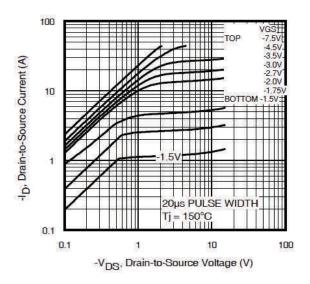


Fig 2. Typical Output Characteristics

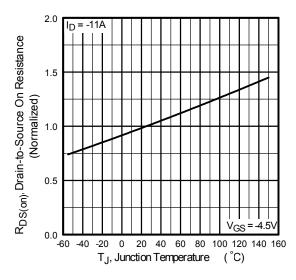


Fig 4. Normalized On-Resistance Vs. Temperature

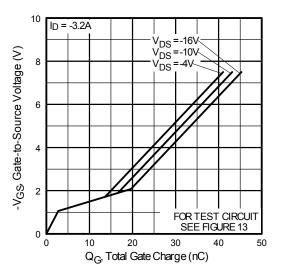


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

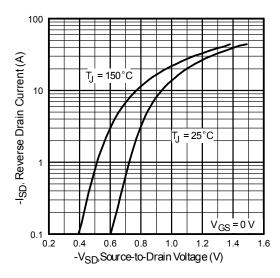


Fig 7. Typical Source-Drain Diode Forward Voltage

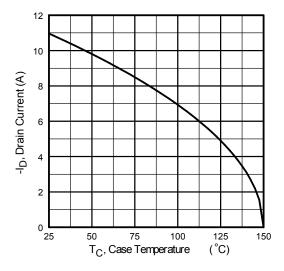


Fig 9. Maximum Drain Current Vs. Case Temperature

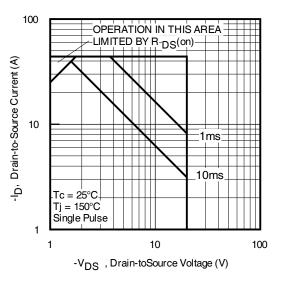


Fig 8. Maximum Safe Operating Area

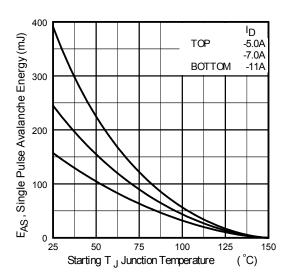


Fig 10. Maximum Avalanche Energy Vs. Drain Current

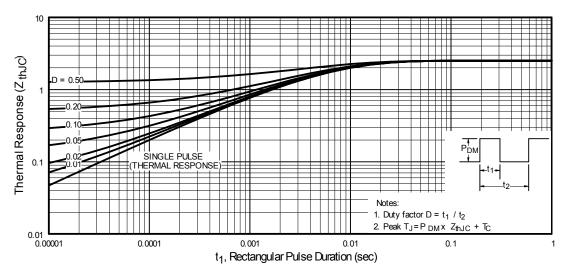


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

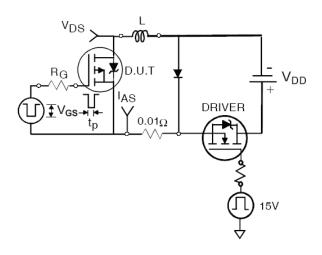


Fig 12a. Unclamped Inductive Test Circuit

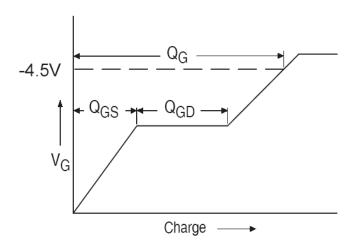


Fig 13a. Basic Gate Charge Waveform

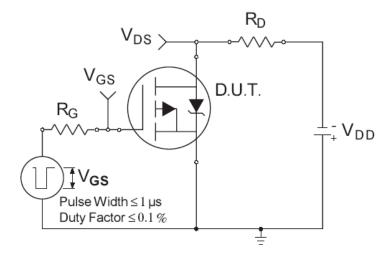


Fig 14a. Switching Time Test Circuit

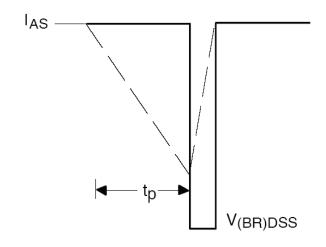


Fig 12b. Unclamped Inductive Waveforms

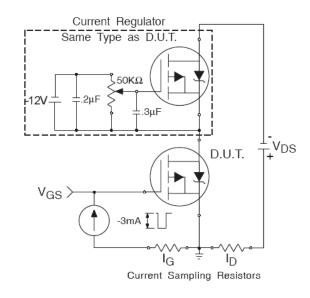


Fig 13b. Gate Charge Test Circuit

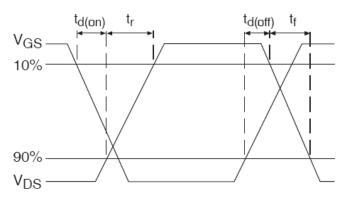
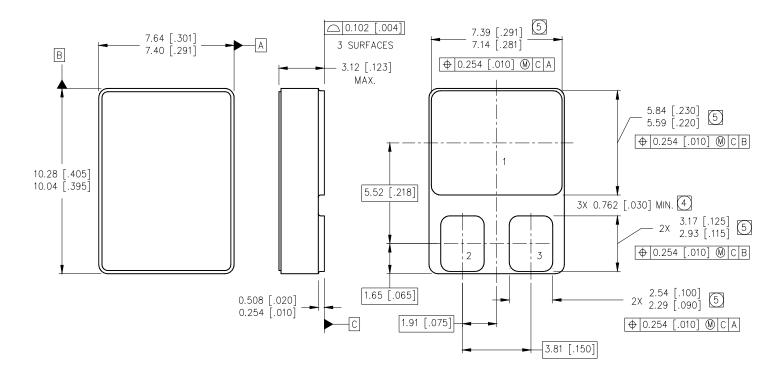


Fig 14b. Switching Time Waveforms



Case Outline and Dimensions — SMD-0.5



NOTES:

- DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994. 1.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].



DIMENSION INCLUDES METALLIZATION FLASH.

DIMENSION DOES NOT INCLUDE METALLIZATION FLASH.

ASSIGNMENTS

MOSFET

DRAIN

2 GATE

SOURCE



www.infineon.com/irhirel

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